

## High-Precision Buffered Voltage Reference

### Features

- Maximum Temperature Coefficient: 50 ppm/°C from -40°C to +125°C
- Initial Accuracy: 0.1%
- Operating Temperature Range: -40 to +125°C
- Low Typical Operating Current: 140 µA
- Line Regulation: 50 ppm/V Maximum
- Load Regulation: 40 ppm/mA Maximum
- 8 Voltage Variants Available:
  - 1.024V
  - 1.250V
  - 1.800V
  - 2.048V
  - 2.500V
  - 3.000V
  - 3.300V
  - 4.096V
- Output Noise: 27 µVRMS, 10 Hz to 10 kHz (1.024V)

### Applications

- Precision Data Acquisition Systems
- High-Resolution Data Converters
- Medical Equipment Applications
- Industrial Controls
- Battery-Powered Devices

### General Description

The MCP1501 is a buffered voltage reference capable of sinking and sourcing 20 mA of current. The voltage reference is a low-drift bandgap-based reference. The bandgap uses chopper-based amplifiers, effectively reducing the drift to zero.

The MCP1501 is available in the following packages:

- 6-Lead SOT-23
- 8-Lead SOIC
- 8-Lead 2 mm x 2 mm WDFN

### Package Types



# MCP1501

## BLOCK DIAGRAM



## 1.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings<sup>(†)</sup>

$V_{DD}$ .....	5.5V
Maximum current into $V_{DD}$ pin .....	30 mA
Clamp current, $I_K$ ( $V_{PIN} < 0$ or $V_{PIN} > V_{DD}$ ).....	$\pm 20$ mA
Maximum output current sunk by OUTPUT pin .....	30 mA
Maximum output current sourced by OUTPUT pin .....	30 mA
(HBM:CDM:MM).....	(2 kV: $\pm 1.5$ kV:200V)

† **Notice:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure above maximum rating conditions for extended periods may affect device reliability.

**TABLE 1-1: DC CHARACTERISTICS**

Electrical Characteristics: Unless otherwise specified, $V_{DD(MIN)} \leq V_{DD} \leq 5.5V$ at $-40^{\circ}C \leq T_A \leq +125^{\circ}C$ .							
Characteristic	Sym.	Min.	Typ.	Max.	Units	Conditions	
Supply Voltage	$V_{DD}$	1.65	—	5.5	V	MCP1501-10	
	$V_{DD}$	1.65	—	5.5	V	MCP1501-12	
	$V_{DD}$	2.0	—	5.5	V	MCP1501-18	
	$V_{DD}$	2.25	—	5.5	V	MCP1501-20	
	$V_{DD}$	2.70	—	5.5	V	MCP1501-25	
	$V_{DD}$	3.2	—	5.5	V	MCP1501-30	
	$V_{DD}$	3.5	—	5.5	V	MCP1501-33	
	$V_{DD}$	4.3	—	5.5	V	MCP1501-40	
Power-on-Reset Release Voltage	$V_{POR}$	—	1.45	—	V		
Power-on-Reset Rearm Voltage	—	—	0.8	—	V		
Output Voltage	MCP1501-10	$V_{OUT}$	1.0230	1.0240	1.0250	V	
	MCP1501-12		1.2488	1.2500	1.2513	V	
	MCP1501-18		1.7982	1.800	1.8018	V	
	MCP1501-20		2.0460	2.0480	2.0500	V	
	MCP1501-25		2.4975	2.500	2.5025	V	
	MCP1501-30		2.9970	3.000	3.0030	V	
	MCP1501-33		3.2967	3.300	3.3033	V	
	MCP1501-40		4.0919	4.0960	4.1001	V	
Temperature Coefficient	MCP1501-XX	$T_C$	—	10	50	ppm/ $^{\circ}C$	
Line Regulation		$\frac{\Delta V_{OUT}}{\Delta V_{IN}}$	—	5	50	ppm/V	
Load Regulation		$\frac{\Delta V_{OUT}}{\Delta I_{OUT}}$	—	10 ppm – sink 15 ppm – source	40 ppm – sink 70 ppm – source	ppm/mA	$-5 \text{ mA} < I_{LOAD} < +5 \text{ mA}$
Dropout Voltage		$V_{DO}$	—	—	200	mV	$-5 \text{ mA} < I_{LOAD} < +2 \text{ mA}$
Power Supply Rejection Ratio		PSRR		94 dB			1.024V option, $V_{IN} = 5.5V$ , 60 Hz at 100 mV <sub>P-P</sub>

# MCP1501

**TABLE 1-1: DC CHARACTERISTICS (CONTINUED)**

Electrical Characteristics: Unless otherwise specified, $V_{DD(MIN)} \leq V_{DD} \leq 5.5V$ at $-40^{\circ}C \leq T_A \leq +125^{\circ}C$ .							
Characteristic	Sym.	Min.	Typ.	Max.	Units	Conditions	
Shutdown	$V_{IL}$		1.35			$V_{IN} = 5.5V$	
	$V_{IH}$		3.80				
Output Voltage Hysteresis	$\Delta V_{OUT\_HYST}$		300 $\mu V$			Refer to <a href="#">Section 1.1.10 "Output Voltage Hysteresis"</a> for additional details on testing conditions.	
Output Noise	MCP1501-10	$e_N$	—	14	—	$\mu VRMS$	0.1 Hz to 10 Hz, $T_A = +25^{\circ}C$
			—	27	—		10 Hz to 10 kHz, $T_A = +25^{\circ}C$
	MCP1501-40	$e_N$	—	20	—	$\mu VRMS$	0.1 Hz to 10 Hz, $T_A = +25^{\circ}C$
			—	110	—		10 Hz to 10 kHz, $T_A = +25^{\circ}C$
Maximum Load Current	$I_{LOAD}$	—	$\pm 20$	—	mA	$T_A = +25^{\circ}C$ 2.048V option	
Supply Current		$I_{DD}$	—	140	550	$\mu A$	No Load
			—	—	350		No Load, $T_A = +25^{\circ}C$
Shutdown Current	MCP1501-10	$I_{SHDN}$		205		nA	$T_A = +25^{\circ}C$
	MCP1501-20			185			
	MCP1501-40			185			

**TABLE 1-2: TEMPERATURE SPECIFICATIONS**

Electrical Specifications: Unless otherwise indicated, all parameters apply at $A_{V_{DD}}, D_{V_{DD}} = 2.7$ to $3.6V$ .						
Parameters	Sym.	Min.	Typ.	Max.	Units	Conditions
<b>Temperature Ranges</b>						
Operating Temperature Range	$T_A$	-40	—	+125	$^{\circ}C$	
Storage Temperature Range	$T_A$	-65	—	+150	$^{\circ}C$	
<b>Thermal Package Resistance</b>						
Thermal Resistance for SOT-23-6	$\theta_{JA}$	—	+190.5	—	$^{\circ}C/W$	
Thermal Resistance for SOIC-8	$\theta_{JA}$	—	+149.5	—	$^{\circ}C/W$	
Thermal Resistance for DFN-8	$\theta_{JA}$	—	+141.3	—	$^{\circ}C/W$	

## 1.1 Terminology

### 1.1.1 OUTPUT VOLTAGE

Output voltage is the reference voltage that is available on the OUT pin.

### 1.1.2 INPUT VOLTAGE

The input voltage ( $V_{IN}$ ) is the range of voltage that can be applied to the  $V_{DD}$  pin and still have the device produce the designated output voltage on the OUT pin.

### 1.1.3 TEMPERATURE COEFFICIENT ( $TC_{OUT}$ )

The output temperature coefficient or voltage drift is a measure of how much the output voltage will vary from its initial value with changes in ambient temperature. The value specified in the electrical specifications is measured as shown in [Equation 1-1](#).

#### EQUATION 1-1: $TC_{OUTPUT}$ CALCULATION

$$TC_{OUT} = \frac{V_{OUT(MAX)} - V_{OUT(MIN)}}{\Delta T \times V_{OUT(NOM)}} \times 10^6 \text{ ppm}/^\circ\text{C}$$

Where:

- $V_{OUT(MAX)}$  = Maximum output voltage over the temperature range
- $V_{OUT(MIN)}$  = Minimum output voltage over the temperature range
- $V_{OUT(NOM)}$  = Average output voltage over the temperature range
- $\Delta T$  = Temperature range over which the data was collected

### 1.1.4 DROPOUT VOLTAGE

The dropout voltage is defined as the voltage difference between  $V_{DD}$  and  $V_{OUT}$  under load. [Equation 1-2](#) is used to calculate the dropout voltage.

#### EQUATION 1-2:

$$V_{DO} = V_{IN} - V_{OUT} / I_{OUT} = \text{Constant}$$

### 1.1.5 LINE REGULATION

An ideal voltage reference will maintain a constant output voltage regardless of any changes to the input voltage. However, when real devices are considered, a small error may be measured on the output when an input voltage change occurs.

Line regulation is defined as the change in output voltage ( $\Delta V_{OUT}$ ) as a function of a change in input voltage ( $\Delta V_{IN}$ ), and expressed as a percentage, as shown in [Equation 1-3](#).

#### EQUATION 1-3:

$$\frac{\Delta V_{OUT}}{\Delta V_{IN}} \times 100\% = \% \text{ Line Regulation}$$

Line regulation may also be expressed as %/V or in ppm/V, as shown in [Equation 1-4](#) and [Equation 1-5](#), respectively.

#### EQUATION 1-4:

$$\left( \frac{\Delta V_{OUT}}{V_{OUT(NOM)}} \right) \times 100\% = \frac{\%}{V} \text{ Line Regulation}$$

#### EQUATION 1-5:

$$\left( \frac{\Delta V_{OUT}}{V_{OUT(NOM)}} \right) \times 10^6 = \frac{\text{ppm}}{V} \text{ Line Regulation}$$

As an example, if the MCP1501-20 is implemented in a design and a 2  $\mu\text{V}$  change in output voltage is measured from a 250 mV change on the input, then the error in percent, ppm, percent/volt, and ppm/volt, as shown in [Equation 1-6](#) – [Equation 1-9](#).

#### EQUATION 1-6:

$$\left( \frac{\Delta V_{OUT}}{\Delta V_{IN}} \times 100\% \right) \times \left( \frac{2 \mu\text{V}}{250 \text{ mV}} \times 100\% \right) = .0008\%$$

#### EQUATION 1-7:

$$\left( \frac{\Delta V_{OUT}}{\Delta V_{IN}} \times 10^6 \right) \times \left( \frac{2 \mu\text{V}}{250 \text{ mV}} \times 10^6 \right) = 8 \text{ ppm}$$

#### EQUATION 1-8:

$$\frac{\Delta V_{OUT}}{\Delta V_{IN}} \times 100\% = \left( \frac{2 \mu\text{V}}{2.048 \text{ V}} \right) \times 100\% = 0.000390625 \frac{\%}{V}$$

#### EQUATION 1-9:

$$\frac{\Delta V_{OUT}}{\Delta V_{IN}} \times 10^6 = \left( \frac{2 \mu\text{V}}{2.048 \text{ V}} \right) \times 10^6 = 3.90625 \frac{\text{ppm}}{V}$$

# MCP1501

## 1.1.6 LOAD REGULATION

An ideal voltage reference will maintain the specified output voltage regardless of the load's current demand. However, real devices experience a small error voltage that deviates from the specified output voltage when a load is present.

Load regulation is defined as the voltage difference when under no load ( $V_{OUT} @ I_{OUT|0}$ ) and under maximum load ( $V_{OUT} @ I_{OUT|MAX}$ ), and is expressed as a percentage, as shown in [Equation 1-10](#).

### EQUATION 1-10:

$$\frac{V_{OUT} @ I_{OUT|0} - V_{OUT} @ I_{OUT|MAX}}{V_{OUT} @ I_{OUT|0}} \times 100\% = \% \text{ Load Regulation}$$

Similar to line regulation, load regulation may also be expressed as %/mA or in ppm/mA as shown in [Equation 1-11](#) and [Equation 1-12](#), respectively.

### EQUATION 1-11:

$$\left( \frac{\Delta V_{OUT}}{V_{OUT(NOM)}} \right) \times 100\% = \frac{\%}{\text{mA}} \text{ Load Regulation}$$

### EQUATION 1-12:

$$\left( \frac{\Delta V_{OUT}}{V_{OUT(NOM)}} \right) \times 10^6 = \frac{\text{ppm}}{\text{mA}} \text{ Load Regulation}$$

As an example, if the MCP1501-20 is implemented in a design and a 10  $\mu\text{V}$  change in output voltage is measured from a 2 mA change on the input, then the error in percent, ppm, percent/volt, ppm/volt, as shown in [Equation 1-13](#) – [Equation 1-16](#).

### EQUATION 1-13:

$$\frac{2.048\text{V} - 2.04799\text{V}}{2.04799\text{V}} \times 100\% = .0004882\%$$

### EQUATION 1-14:

$$\frac{2.048\text{V} - 2.04799\text{V}}{2.04799\text{V}} \times 10^6 = \left( \frac{2.048\text{V} - 2.04799\text{V}}{2.04799\text{V}} \times 10^6 \right) = 4.882 \text{ ppm}$$

### EQUATION 1-15:

$$\left( \frac{\Delta V_{OUT}}{V_{OUT(NOM)}} \right) \times 100\% = \left( \frac{\left( \frac{10 \mu\text{V}}{2.048\text{V}} \right)}{2 \text{ mA}} \right) \times 100\% = 0.2441 \frac{\%}{\text{mA}}$$

### EQUATION 1-16:

$$\left( \frac{\Delta V_{OUT}}{V_{OUT(NOM)}} \right) \times 10^6 = \left( \frac{\left( \frac{10 \mu\text{V}}{2.048\text{V}} \right)}{2 \text{ mA}} \right) \times 10^6 = 2.441 \frac{\text{ppm}}{\text{mA}}$$

## 1.1.7 INPUT CURRENT

The input current (operating current) is the current that sinks from  $V_{IN}$  to GND without a load current on the output pin. This current is affected by temperature, input voltage, output voltage, and the load current.

## 1.1.8 POWER SUPPLY REJECTION RATIO

Power supply rejection ratio (PSRR) is a measure of the change in output voltage ( $\Delta V_{OUT}$ ) relative to the change in input voltage ( $\Delta V_{IN}$ ) over frequency.

## 1.1.9 LONG-TERM DRIFT

The long-term output stability is measured by exposing the devices to an ambient temperature of +125°C, as shown in [Figure 2-18](#) while configured in the circuit shown in [Figure 1-1](#). In this test, all electrical specifications of the devices are measured periodically at +25°C.



**FIGURE 1-1:** Long-Term Drift Test Circuit.

## 1.1.10 OUTPUT VOLTAGE HYSTERESIS

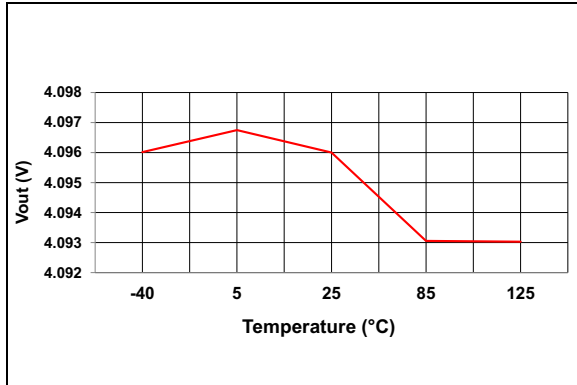
The output voltage hysteresis is a measure of the output voltage error after the powered devices are cycled over the entire operating temperature range. The amount of hysteresis can be quantified by measuring the change in the +25°C output voltage after temperature excursions from +25°C to +125°C to +25°C, and also from +25°C to -40°C to +25°C.

# MCP1501

## 2.0 TYPICAL OPERATING CURVES

**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

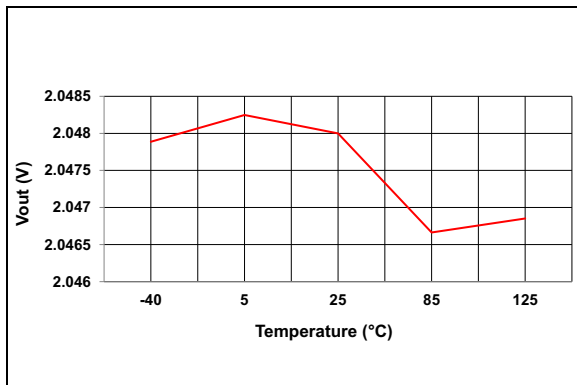
**Note:** Unless otherwise specified, maximum values are:  $V_{DD(MIN)} \leq V_{DD} \leq 5.5V$  at  $-40^{\circ}C \leq T_A \leq +125^{\circ}C$ .



**FIGURE 2-1:**  $V_{OUT}$  vs. Temperature, No Load, 4.096V Option.



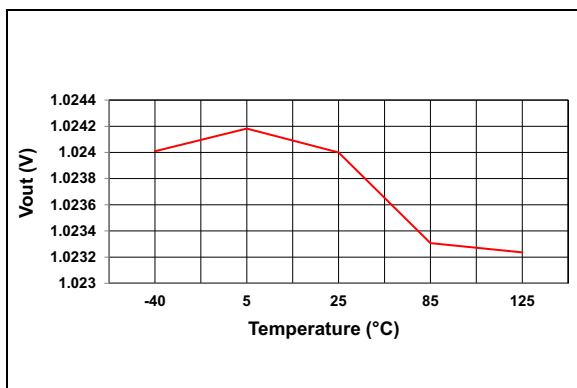
**FIGURE 2-4:** Load Regulation vs. Temperature,  $I_{LOAD}$  5mA Sink.



**FIGURE 2-2:**  $V_{OUT}$  vs. Temperature, No Load, 2.048V Option.



**FIGURE 2-5:** Load Regulation vs. Temperature,  $I_{LOAD}$  5mA Source.

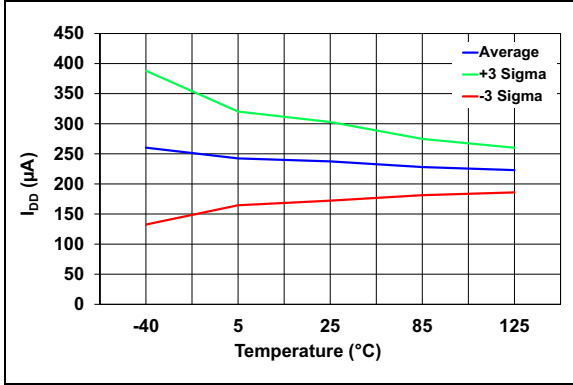


**FIGURE 2-3:**  $V_{OUT}$  vs. Temperature, No Load, 1.024V Option.

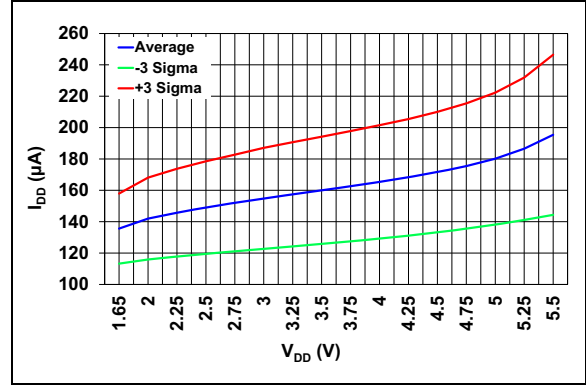


**FIGURE 2-6:**  $I_{DD}$  vs. Temperature, All Options.

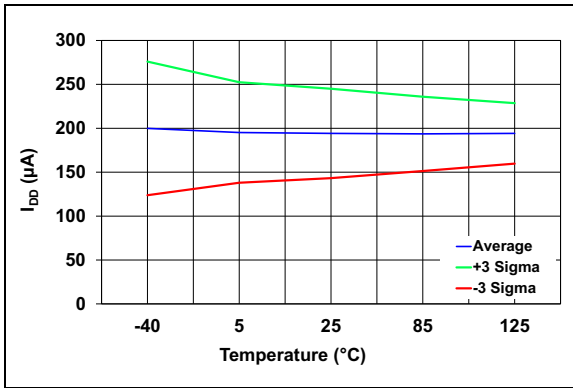




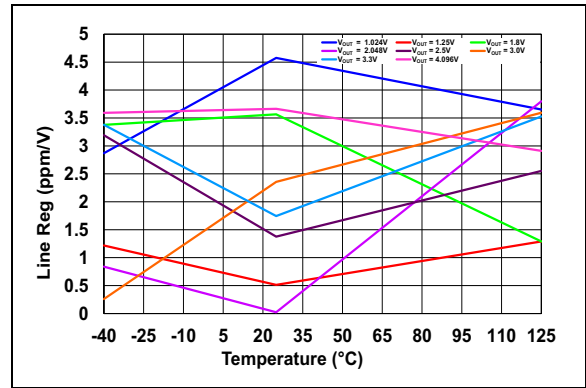
**FIGURE 2-7:**  $I_{DD}$  vs. Temperature for  $V_{OUT}$ , 50 Units, No Load, 4.096V Option.



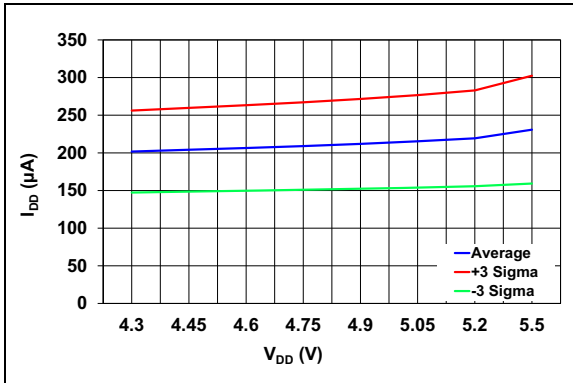
**FIGURE 2-10:**  $I_{DD}$  vs.  $V_{DD}$ ,  $V_{OUT} = 1.024V$ , 50 Units, No Load.



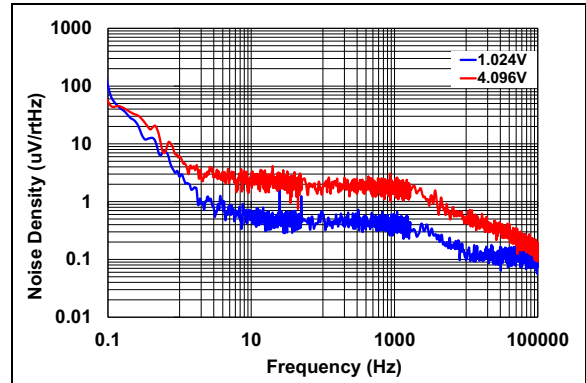
**FIGURE 2-8:**  $I_{DD}$  vs. Temperature for  $V_{OUT}$ , 50 Units, No Load, 1.024V Option.



**FIGURE 2-11:** Line Regulation vs. Temperature.



**FIGURE 2-9:**  $I_{DD}$  vs.  $V_{DD}$ ,  $V_{OUT} = 4.096V$ , 50 Units, No Load.



**FIGURE 2-12:** Noise vs. Frequency, No Load,  $T_A = +25^\circ C$ .

# MCP1501



**FIGURE 2-13:** PSRR vs. Frequency, No Load,  $T_A = +25^\circ\text{C}$ .



**FIGURE 2-16:** Tempco Distribution, No Load,  $T_A = +25^\circ\text{C}$ ,  $V_{DD} = 2.7\text{V}$ , 50 Units.



**FIGURE 2-14:** PSRR vs. Frequency, 1 k $\Omega$  Load,  $T_A = +25^\circ\text{C}$ .



**FIGURE 2-17:** Tempco Distribution, No Load,  $T_A = +25^\circ\text{C}$ ,  $V_{DD} = 5.5\text{V}$ , 50 Units.



**FIGURE 2-15:** Dropout Voltage vs. Load,  $T_A = +25^\circ\text{C}$ , 2.048V Option.



**FIGURE 2-18:**  $V_{OUT}$  Drift vs. Time,  $T_A = +25^\circ\text{C}$ , No Load, 800 Units.



**FIGURE 2-19:**  $V_{OUT}$  vs. Load,  $T_A = +25^\circ\text{C}$ , 2.048V Option.



**FIGURE 2-22:** Turn On Transient,  $V_{DD} = 5/5\text{V}$ ,  $V_{IN} = 2.048\text{V}$  Option, No Load.



**FIGURE 2-20:**  $V_{OUT}$  at  $V_{DDMIN}$ ,  $V_{DD} = 2.7\text{V}$ , 800 Units, 2.5V Option, No Load.



**FIGURE 2-23:** Line Transient,  $V_{DD} = 5.5\text{V}$ ,  $V_{IN} = 500\text{mV}_{PP}$  @  $5\text{V}_{DC}$ , 2.048V Option, No Load.



**FIGURE 2-21:**  $V_{OUT}$  Distribution at  $V_{DDMAX}$ ,  $V_{DD} = 5.5\text{V}$ , 800 Units, 2.5V Option, No Load.



**FIGURE 2-24:** Load Transient,  $V_{DD} = 5.5\text{V}$ ,  $V_{IN} = 2.5\text{V}$ , 2.048V Option.

# MCP1501



**FIGURE 2-25:**  $R_{ISO}$  vs.  $C_{LOAD}$ , 4.096V  
Option Unloaded.



**FIGURE 2-26:**  $R_{ISO}$  vs.  $C_{LOAD}$ , 4.096V  
Option Loaded.

### 3.0 PIN FUNCTION TABLE

The pin functions are described in [Table 3-1](#).

**TABLE 3-1: PIN FUNCTION TABLE**

SOT-23	SOIC	2 x 2 WDFN	Symbol	Function
1	7	7	OUT	Buffered $V_{REF}$ Output
—	8	8	FEEDBACK	Buffered $V_{REF}$ Feedback
2, 3, 5	2, 4, 5, 6	2, 4, 5, 6	GND	System Ground
4	3	3	$\overline{\text{SHDN}}$	Shutdown Pin Active Low
6	1	1	$V_{DD}$	Power Supply Input
—	—	9	EP	Exposed Thermal Pad

#### 3.1 Buffered $V_{REF}$ Output (OUT)

This is the Buffered Reference Output. On the WDFN and SOIC package, this should be connected to the FEEDBACK pin at the device. The output driver is tristated when in shutdown.

#### 3.2 Buffered $V_{REF}$ Feedback (FEEDBACK)

This is the buffer amplifier feedback pin. On the WDFN and SOIC package, this should be connected to the OUT pin at the device. This connection is internal on the SOT-23 package. Note that if there is routing impedance or IR-drop between the OUT and FEEDBACK pins, it is the FEEDBACK pin which accurately holds the output voltage. This can be used in an application to remove IR-drop effects on output voltage caused by the Printed Circuit Board (PCB) or interconnect resistance with a high-current load.

#### 3.3 System Ground (GND)

This is the power supply return and should be connected to system ground.

#### 3.4 Shutdown Pin ( $\overline{\text{SHDN}}$ )

This is a digital input that will place the device in Shutdown. The device should be allowed to power up before using this feature. This pin is active low.

#### 3.5 Power Supply Input ( $V_{DD}$ )

This power pin also serves as the input voltage for the voltage reference. Refer to the Electrical Tables to determine minimum voltage, based on the device.

#### 3.6 Exposed Thermal Pad (EP)

Not internally connected, but recommend grounding.

# MCP1501

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## 4.0 THEORY OF OPERATION

The MCP1501 is a buffered voltage reference that is capable of operating over a wide input supply range while providing a stable output across the input supply range. The fundamental building block (see [Block Diagram](#)) of the MCP1501 is an internal bandgap reference circuit. As with all bandgap circuits, the internal reference sums together two voltages having an opposite temperature coefficient which allows a voltage reference that is practically independent from temperature.

The bandgap of the MCP1501 is based on a second order temperature coefficient (TC) compensated bandgap circuit that allows the MCP1501 to achieve high initial accuracy and low temperature coefficient operation across supply and ambient temperature. The bandgap curvature compensation is determined during device characterization and is trimmed for optimal accuracy.

The MCP1501 also includes a chopper-based amplifier architecture that ensures excellent low-noise operation, further reduces temperature dependent offsets that would otherwise increase the temperature coefficient of the MCP1501, and significantly improves long-term drift performance. Additional circuitry is included to eliminate the chopping frequency from the output of the device.

After the bandgap voltage is compensated, it is amplified, buffered, and provided to the output drive circuit which has excellent performance when sinking or sourcing load currents ( $\pm 5$  mA).

## 5.0 APPLICATION CIRCUITS

### 5.1 Application Tips

#### 5.1.1 BASIC APPLICATION CIRCUIT

Figure 5-1 illustrates a basic circuit configuration of the MCP1501.



**FIGURE 5-1:** Basic Circuit Configuration.

An output capacitor is not required for stability of the voltage reference, but may be optionally added to provide noise filtering or act as a charge-reservoir for switching loads, e.g., successive approximation register (SAR) analog-to-digital converter (ADC). As shown, the input voltage is connected to the device at the  $V_{IN}$  input, with an optional 2.2  $\mu\text{F}$  ceramic capacitor. This capacitor would be required if the input voltage has excessive noise. A 2.2  $\mu\text{F}$  capacitor would reject input voltage noise at approximately 1 to 2 MHz. Noise below this frequency will be amply rejected by the input voltage rejection of the voltage reference. Noise at frequencies above 2 MHz will be beyond the bandwidth of the voltage reference and, consequently, not transmitted from the input pin through the device to the output.

If the noise at the output of these voltage references is too high for the particular application, it can be easily filtered with an external RC filter and op-amp buffer (see Figure 5-2).



**FIGURE 5-2:** Output Noise-Reducing Filter.

# MCP1501

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The RC filter values are selected for a desired cutoff frequency, as shown in [Equation 5-1](#).

## EQUATION 5-1:

$$f_C = \frac{1}{2\pi(R_{FIL}C_{FIL})}$$

The values that are shown in [Figure 5-2](#) (10 k $\Omega$  and 1  $\mu$ F) will create a first-order, low-pass filter at the output of the amplifier. The cutoff frequency of this filter is 15.9 Hz, and the attenuation slope is 20 dB/decade. The MCP6021 amplifier isolates the loading of this low-pass filter from the remainder of the application circuit. This amplifier also provides additional drive, with a faster response time than the voltage reference.

### 5.1.2 LOAD CAPACITOR

The maximum capacitive load is 300 pF. However, larger capacitors may be implemented if a resistor is used in series with a larger load capacitor. Refer to [Figure 2-25](#) and [Figure 2-26](#) to ensure adequate phase margin when selecting a resistor/capacitor combination.

### 5.1.3 PRINTED CIRCUIT BOARD LAYOUT CONSIDERATIONS

Mechanical stress due to Printed Circuit Board (PCB) mounting can cause the output voltage to shift from its initial value. Devices in the SOT-23-6 package are generally more prone to assembly stress than devices in the WDFN package. To reduce stress-related output voltage shifts, mount the reference on low-stress areas of the PCB (i.e., away from PCB edges, screw holes and large components).



## 5.2 Typical Applications Circuits

### 5.2.1 NEGATIVE VOLTAGE REFERENCE

A negative voltage reference can be generated using any of the devices in the MCP1501 family. A typical application is shown in Figure 5-3. In this circuit, the voltage inversion is implemented using the MCP6061 and two equal resistors. The voltage at the output of the MCP1501 voltage reference drives R1, which is connected to the inverting input of the MCP6061 amplifier.

Since the noninverting input of the amplifier is biased to ground, the inverting input will also be close to ground potential. The second 10 kΩ resistor is placed around the feedback loop of the amplifier. Since the inverting input of the amplifier is high-impedance, the current generated through R1 will also flow through R2. As a consequence, the output voltage of the amplifier is equal to -2.5V for the MCP1501-25 and -4.096V for the MCP1501-40.



FIGURE 5-3: Negative Voltage Reference.

### 5.2.2 A/D CONVERTER REFERENCE

The MCP1501 product family was carefully designed to provide a precision, low noise voltage reference for the Microchip families of ADCs. The circuit shown in Figure 5-4 shows a MCP1501-25 configured to provide the reference to the MCP3201, a 12-bit ADC.



FIGURE 5-4: ADC Example Circuit.

# MCP1501



**FIGURE 5-5:** SAR ADC Example Circuit.

The circuit shown in [Figure 5-5](#) shows a MCP1501-25 configured to provide the reference to a 14-bit or 16-bit SAR ADC.

## 6.0 PACKAGE INFORMATION

### 6.1 Package Markings

6-Lead SOT-23



Device	Code
MCP1501T-10E/CHY	AABTY
MCP1501T-12E/CHY	AABUY
MCP1501T-18E/CHY	AABVY
MCP1501T-20E/CHY	AABWY
MCP1501T-25E/CHY	AABXY
MCP1501T-30E/CHY	AABYY
MCP1501T-33E/CHY	AABZY
MCP1501T-40E/CHY	AACAY

Example



8-Lead SOIC



Device	Code
MCP1501T-10E/SN	150110
MCP1501T-12E/SN	150112
MCP1501-18E/SN	150118
MCP1501-20E/SN	150120
MCP1501T-25E/SN	150125
MCP1501T-30E/SN	150130
MCP1501T-33E/SN	150133
MCP1501T-40E/SN	150140

Example



8-Lead WDFN (2 x2 mm)



Device	Code
MCP1501T-10E/RW	AAQ
MCP1501T-12E/RW	AAR
MCP1501-18E/RW	AAS
MCP1501-20E/RW	AAT
MCP1501T-25E/RW	AAU
MCP1501T-30E/RW	AAV
MCP1501T-33E/RW	AAW
MCP1501T-40E/RW	AAX

Example



<b>Legend:</b>	XX...X	Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC® designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.

**Note:** In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

# MCP1501

## 6-Lead Plastic Small Outline Transistor (CH, CHY) [SOT-23]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Microchip Technology Drawing C04-028C (CH) Sheet 1 of 2

## 6-Lead Plastic Small Outline Transistor (OT, OTY) [SOT-23]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Number of Leads	N	6		
Pitch	e	0.95 BSC		
Outside lead pitch	e1	1.90 BSC		
Overall Height	A	0.90	-	1.45
Molded Package Thickness	A2	0.89	1.15	1.30
Standoff	A1	0.00	-	0.15
Overall Width	E	2.80 BSC		
Molded Package Width	E1	1.60 BSC		
Overall Length	D	2.90 BSC		
Foot Length	L	0.30	0.45	0.60
Footprint	L1	0.60 REF		
Seating Plane to Gauge Plane	L1	0.25 BSC		
Foot Angle	$\phi$	0°	-	10°
Lead Thickness	c	0.08	-	0.26
Lead Width	b	0.20	-	0.51

**Notes:**

- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25mm per side.
- Dimensioning and tolerancing per ASME Y14.5M  
 BSC: Basic Dimension. Theoretically exact value shown without tolerances.  
 REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-028C (OT) Sheet 2 of 2

# MCP1501

## 8-Lead Plastic Small Outline (SN) - Narrow, 3.90 mm (.150 In.) Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Microchip Technology Drawing No. C04-057-SN Rev D Sheet 1 of 2

## 8-Lead Plastic Small Outline (SN) - Narrow, 3.90 mm (.150 In.) Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Number of Pins	N	8		
Pitch	e	1.27 BSC		
Overall Height	A	-	-	1.75
Molded Package Thickness	A2	1.25	-	-
Standoff §	A1	0.10	-	0.25
Overall Width	E	6.00 BSC		
Molded Package Width	E1	3.90 BSC		
Overall Length	D	4.90 BSC		
Chamfer (Optional)	h	0.25	-	0.50
Foot Length	L	0.40	-	1.27
Footprint	L1	1.04 REF		
Foot Angle	$\varphi$	0°	-	8°
Lead Thickness	c	0.17	-	0.25
Lead Width	b	0.31	-	0.51
Mold Draft Angle Top	$\alpha$	5°	-	15°
Mold Draft Angle Bottom	$\beta$	5°	-	15°

**Notes:**

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm per side.
- Dimensioning and tolerancing per ASME Y14.5M
  - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
  - REF: Reference Dimension, usually without tolerance, for information purposes only.
- Datums A & B to be determined at Datum H.

Microchip Technology Drawing No. C04-057-SN Rev D Sheet 2 of 2

# MCP1501

## 8-Lead Plastic Small Outline (SN) - Narrow, 3.90 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Contact Pitch	E	1.27 BSC		
Contact Pad Spacing	C		5.40	
Contact Pad Width (X8)	X1			0.60
Contact Pad Length (X8)	Y1			1.55

**Notes:**

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-2057-SN Rev B



## 8-Lead Very, Very Thin Plastic Dual Flat, No Lead Package (RW) - 2x2 mm Body [WDFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Microchip Technology Drawing C04-261A Sheet 1 of 2

# MCP1501

## 8-Lead Very, Very Thin Plastic Dual Flat, No Lead Package (RW) - 2x2 mm Body [WDFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Number of Terminals	N	8		
Pitch	e	0.50 BSC		
Overall Height	A	0.70	0.75	0.80
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	(A3)	0.10 REF		
Overall Width	E	2.00 BSC		
Exposed Pad Width	E2	0.70	0.80	0.90
Overall Length	D	2.00 BSC		
Exposed Pad Length	D2	1.10	1.20	1.30
Exposed Pad Chamfer	CH	-	0.25	-
Terminal Width	b	0.20	0.25	0.30
Terminal Length	L	0.25	0.30	0.35
Terminal-to-Exposed-Pad	(K)	0.30	-	-

**Notes:**

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated
3. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-261A Sheet 2 of 2

## 8-Lead Very, Very Thin Plastic Dual Flat, No Lead Package (RW) - 2x2 mm Body [WDFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



### RECOMMENDED LAND PATTERN

Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Contact Pitch	E	0.50 BSC		
Optional Center Pad Width	Y2			0.90
Optional Center Pad Length	X2			1.30
Contact Pad Spacing	C		2.10	
Center Pad Chamfer	CH		0.28	
Contact Pad Width (X8)	X1			0.30
Contact Pad Length (X8)	Y1			0.70
Contact Pad to Contact Pad (X6)	G1	0.20		
Contact Pad to Center Pad (X8)	G1		0.25 REF	
Thermal Via Diameter	V		0.30	

**Notes:**

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerances, for reference only.

Microchip Technology Drawing C04-2261A

# MCP1501

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NOTES:

## APPENDIX A: REVISION HISTORY

### Revision E (August 2017)

The following is the list of modifications:

- Updated [Features](#).
- Updated [Package Types](#).
- Updated [Section 1.0, Electrical Characteristics](#), [Table 1-1](#).
- Updated [Figure 2-12](#), [Figure 2-20](#) and [Figure 2-21](#).
- Updated [Table 3-1](#).
- Updated [Section 3.4, Shutdown Pin \(SHDN\)](#).
- Updated [Section 5.1.2, LOAD CAPACITOR](#).
- Corrected [Figure 5-3](#) and [Figure 5-4](#).
- Added [Figure 5-5](#).
- Minor typographical corrections.

### Revision D (March 2017)

The following is the list of modifications:

- Updated [Table 1-1](#).
- Updated [Equation 1-1](#), [Equation 1-4](#), [Equation 1-5](#), [Equation 1-10](#), [Equation 1-11](#), [Equation 1-12](#) and [Equation 1-16](#).
- Updated [Figure 2-11](#), [Figure 2-20](#), [Figure 2-21](#), [Figure 2-25](#) and [Figure 2-26](#).
- Updated [Figure 5-1](#) and [Figure 5-4](#).
- Updated **“Product Identification System”** section.
- Minor typographical corrections.

### Revision C (May 2016)

The following is the list of modifications:

- Updated [Section 1.0, Electrical Characteristics](#), [Section 4.0, Theory of Operation](#), [Section 5.0, Application Circuits](#).
- Updated [Features](#) section, [General Description](#) section, [Section 3.1, Buffered V<sub>REF</sub> Output \(OUT\)](#).
- Updated **“Product Identification System”** section.
- Updated [Figure 2-12](#), [Figure 2-20](#), [Figure 2-21](#), [Figure 5-1](#) and [Figure 5-4](#).
- Updated [Equation 1-10](#) and [Equation 1-16](#).
- Minor typographical corrections.

### Revision B (January 2016)

The following is the list of modifications:

- Updated [Section 6.0, Package Information](#).
- Updated **“Product Identification System”** section.
- Minor typographical corrections.

### Revision A (December 2015)

Original Release of this Document.

# MCP1501

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NOTES:

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.-	[X] <sup>(1)</sup>	X	/XX	
Device	Tape and Reel	Output Voltage Option	Package	
<p><b>Device:</b> MCP1501 – 50 ppm maximum thermal drift buffered reference</p> <p><b>Tape and Reel Option:</b> Blank = Standard packaging (tube or tray) T = Tape and Reel <sup>(1)</sup></p> <p><b>Output Voltage Option:</b> 10 = 1.024V 12 = 1.200V 18 = 1.800V 20 = 2.048V 25 = 2.500V 30 = 3.000V 33 = 3.300V 40 = 4.096V</p> <p><b>Package:</b> CHY* = 6-Lead Plastic Small Outline Transistor (SOT-23) SN = 8-Lead Plastic Small Outline – Narrow, 3.90 mm Body (SOIC) RW = 8-Lead Very, Very Thin Plastic Dual Flat, No Lead Package – 2 x 2 mm Body (WDFN) *Y = Nickel palladium gold manufacturing designator. Only available on the SOT-23 package.</p>				
				<p><b>Examples:</b></p> <p>a) MCP1501T-10E/CHY: 1.024V, 6-lead SOT-23 package, Tape and Reel</p> <p>b) MCP1501-12E/SN: 1.2V, 8-lead SOIC package</p> <p>c) MCP1501T-18E/SN: 1.8V, 8-lead SOIC package, Tape and Reel</p> <p>d) MCP1501T-20E/RW: 2.048V, 8-lead WDFN package, Tape and Reel</p> <p><b>Note 1:</b> Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip sales office for package availability for the Tape and Reel option.</p>

# MCP1501

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NOTES:



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Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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